TOSHIBA Field Effect Transistor Silicon N, P Channel MOS Type (P Channel U-MOS IV/N Channel U-MOS III)

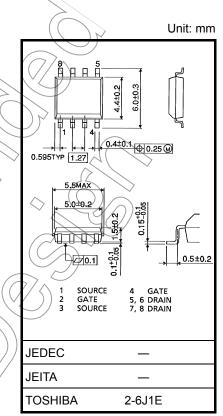
TPC8405

Lithium Ion Secondary Battery Applications Portable Equipment Applications Notebook PC Applications

- Low drain-source ON resistance : P Channel R_{DS} (ON) = 25 m Ω (typ.) N Channel R_{DS} (ON) = 20 m Ω (typ.)
- High forward transfer admittance : P Channel $|Y_{fs}| = 12S$ (typ.)
 - N Channel $|Y_{fs}| = 14S$ (typ.)
- Low leakage current : P Channel $I_{DSS} = -10 \ \mu A \ (V_{DS} = -30 \ V)$ N Channel $I_{DSS} = 10 \ \mu A \ (V_{DS} = 30 \ V)$
- Enhancement-mode
 - : P Channel V_{th} = -0.8 to -2.0 V (V_{DS} = -10 V, I_D = -1 mA) N Channel V_{th} = 1.3 to 2.5 V (V_{DS} = 10 V, I_D = 1 mA)

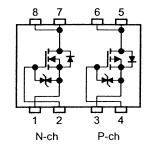
Absolute Maximum Ratings (Ta = 25°C)

	•	-	-	$\langle \rangle$	
С	Symbol	Rat P Channel	ing N Channel	Unit	
Drain-source v	voltage	V _{DSS}	730	30	V
Drain-gate vol	tage (R _{GS} = 20 kΩ)	V _{DGR}	-30	> 30	V
Gate-source v	oltage	V _{GSS}	±20	±20	X
Drain current	DC (Note 1)	ID \	-4.5	6	A
	Pulse (Note 1)	IDP .	-18	24 🚫	
Drain power dissipation Single-device operation (Note 3a)		PD (1)	1.5	1.5	$\langle \vee \rangle$
(t = 10s) (Note 2a)	Single-device value at dual operation (Note 3b)	PD (2)	1.1) w
Drain power dissipation	Single-device operation (Note 3a)	7P _{D (1)}	0.75	0.75	vv
(t = 10s) (Note 2b)	Single-device value at dual operation (Note 3b)	P _{D (2)}	0.45	0.45	
Single pulse a	EAS	13.2 (Note 4a)	23.4 (Note 4b)	mJ	
Avalanche cur	Įar (-4.5	6	А	
Repetitive ava Single-device	EAR	0.1		mJ	
Channel temp	Ten	1:	°C		
Storage tempe	T _{stg}	−55 t	°C		



Weight: 0.080 g (typ.)

Circuit Configuration



Note: For Notes 1 to 5, refer to the next page.

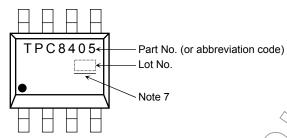
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Handle with care.

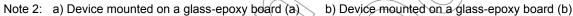
Thermal Characteristics

Characteristics	Symbol	Max	Unit	
The median is the second to embiant	Single-device operation (Note 3a)	R _{th (ch-a) (1)}	83.3	
Thermal resistance, channel to ambient (t = 10s) (Note 2a)	Single-device value at dual operation (Note 3b)	R _{th (ch-a)} (2)	114	°C/W
Thermal resistance, channel to ambier	Single-device operation (Note 3a)	R _{th (ch-a)} (1)	167	
	Single-device value at dual operation (Note 3b)	R _{th (ch-a)} (2)	278	

Marking (Note 6)



Note 1: Ensure that the channel temperature does not exceed 150°C.





Note 3: a) The power dissipation and thermal resistance values shown are for a single device. (During single-device operation, power is applied to one device only.)
b) The power dissipation and thermal resistance values shown are for a single device. (During dual operation, power is evenly applied to both devices.)

- Note 4: a) $V_{DD} = 24 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 0.5 mH, $R_G = 25 \Omega$, $I_{AR} = -4.5 \text{ A}$ b) $V_{DD} = 24 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 0.5 mH, $R_G = 25 \Omega$, $I_{AR} = 6.0 \text{ A}$
- Note 5: Repetitive rating: pulse width limited by maximum channel temperature

Note 6: • on the lower left of the marking indicates Pin 1.



Note 7: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

P-ch

Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage ci	urrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V		_	±10	μA
Drain cut-OFF of	current	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V	X	_	-10	μA
Drain-source br	eakdown	V (BR) DSS	I _D = -10 mA, V _{GS} = 0 V	(-30	4	_	V
voltage		V (BR) DSX	I _D = -10 mA, V _{GS} = 20 V	<u>5</u>	2_	-	v
Gate threshold	voltage	V _{th}	$V_{DS} = -10 V, I_D = -1 mA$	-0.8	—	-2.0	V
Drain-source O	N resistance	R _{DS (ON)}	$V_{GS} = -4.5 \text{ V}, \text{ I}_{\text{D}} = -2.2 \text{ A}$) L	32	42	mΩ
	IN TESISIANCE	R _{DS (ON)}	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -2.2 \text{ A}$	> —	25	33	11152
Forward transfe	er admittance	Y _{fs}	V _{DS} = -10 V, I _D = -2.2 A	6	12	-	S
Input capacitan	се	C _{iss}	$\langle \rangle$		1540	4	
Reverse transfer capacitance		C _{rss}	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	- (220		pF
Output capacita	ince	C _{oss}		-((250	_	
Switching time	Rise time	tr	$V_{\text{GS}} = 10 V$ $I_{\text{D}} = -2.2 \text{ A}$		5.0) _	
	Turn-ON time	t _{on}		\mathcal{A}	13	_	
	Fall time	t _f) —	35	_	ns
	Turn-OFF time	t _{off}	$V_{DD} = -15 V$ Duty \ge 1%, t _w = 10 \mu s	_	125	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	40	_	
Gate-source charge 1		Q _{gs1}	V _{DD} ≈ −24 V, V _{GS} = −10 V, I _D = −4.5 A	—	4.4	_	nC
Gate-drain ("miller") charge		Qgd		_	8.2	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current Rulse (Note 1) I _{DRP}	-	_	_	-18	A
Forward voltage (diode)	V _{DSF}	I _{DR} = -4.5 A, V _{GS} = 0 V	_	_	1.2	V

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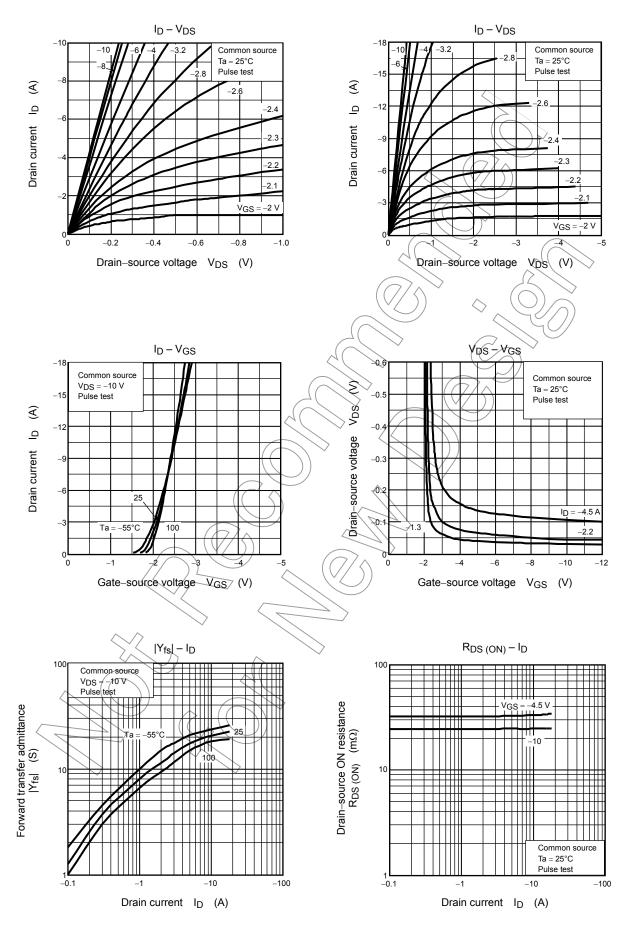
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage c	urrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V		—	±10	μA
Drain cut-OFF of	current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	λ	—	10	μA
Drain-source br	eakdown	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	(30	Z	_	v
voltage		V (BR) DSX	I _D = 10 mA, V _{GS} = -20 V	55	2_	—	v
Gate threshold	voltage	V _{th}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$	1.3	—	2.5	V
Drain-source O	Nresistance	R _{DS (ON)}	V_{GS} = 4.5 V, I _D = 3 A	Z	25	33	mΩ
	IN TESISIONEE	R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$	> —	20	26	11152
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 3 A	7	14	_	S
Input capacitan	ce	C _{iss}	$\langle \langle \rangle \rangle$		1240	\searrow	
Reverse transfer capacitance		C _{rss}	$V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz$		2 180	_	pF
Output capacitance		Coss		-(C	230		
Switching time	Rise time	tr	$V_{GS_{0V}}$ $I_{D} = 3.0 \text{ A}$		4.5	_	
	Turn-ON time	t _{on}	$\begin{array}{c c} & \mathbf{V} & \mathbf{V} \\ & V$	Ð	12.5	_	
	Fall time	t _f) _	6.6	_	ns
	Turn-OFF time	t _{off}	$V_{DD} \stackrel{>}{\Rightarrow} 15 V$ Duty $\stackrel{\leq}{=} 1\%$, t _w $\stackrel{=}{=} 10 \mu s$		33	_	
Total gate charge (Gate-source plus gate-drain)		Qg		_	27	_	
Gate-source charge 1		Q _{gs1}	$V_{DD} \approx 24 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 6 \text{ A}$	—	3.9	_	nC
Gate-drain ("miller") charge		Qgd		_	7.0	_	

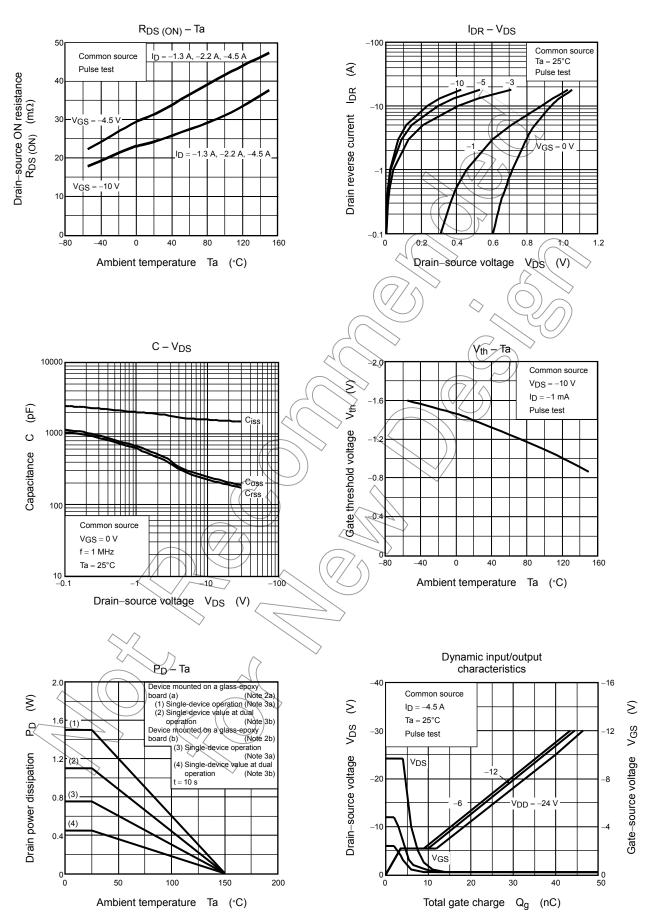
Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics Symbol Test Condition	Min	Тур.	Max	Unit
Drain reverse Pulse (Note 1) I _{DRP} —	-	_	24	А
Forward voltage (diode) V _{DSF} I _{DR} = 6 A, V _{GS} = 0 V	—		-1.2	V

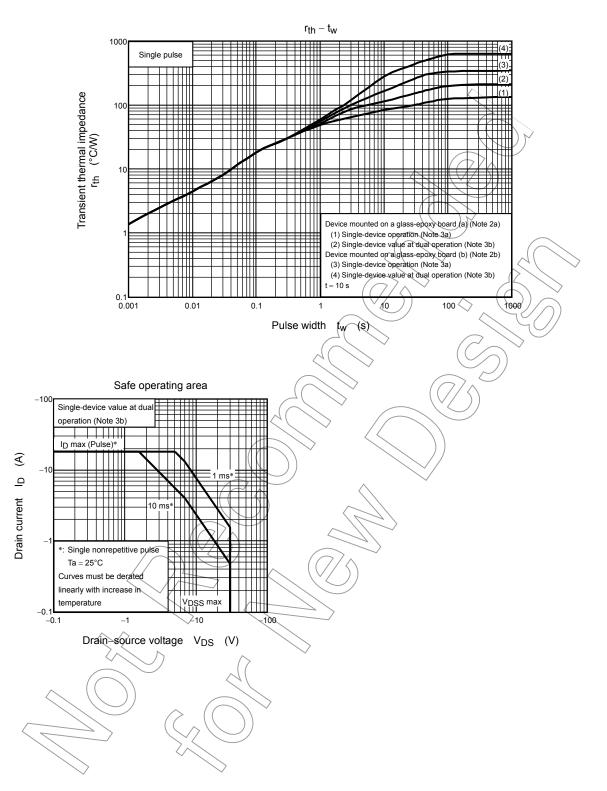
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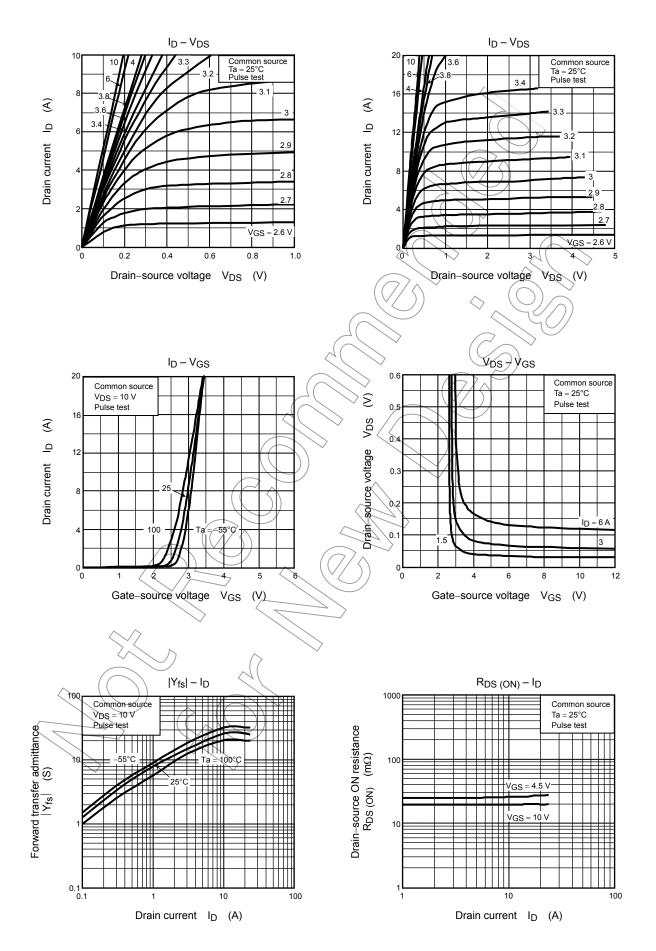


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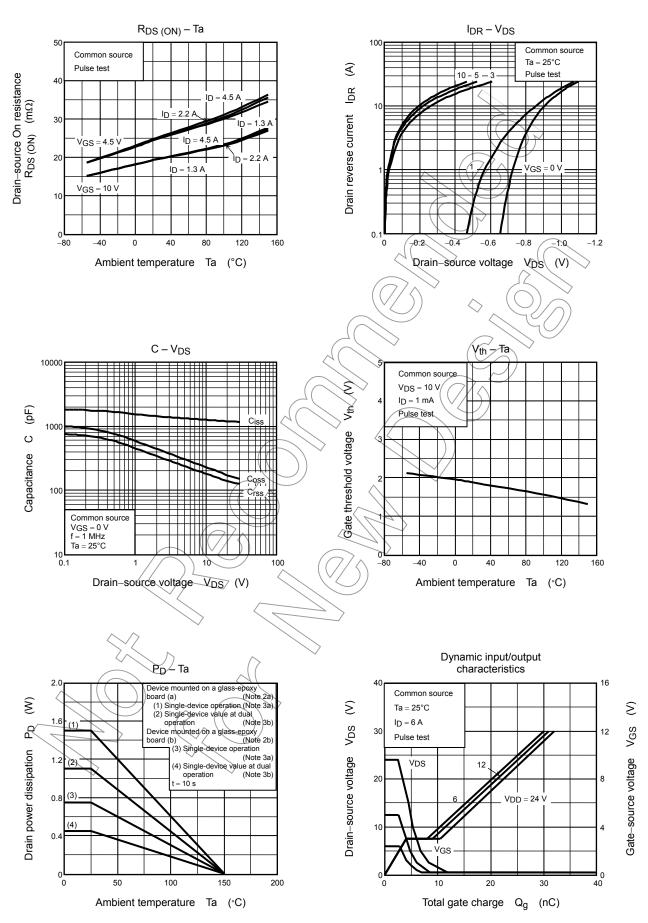


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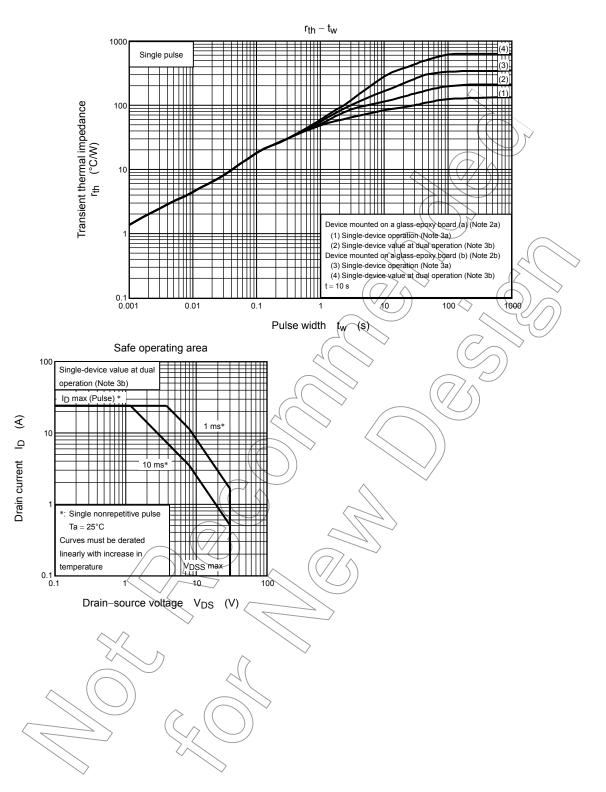
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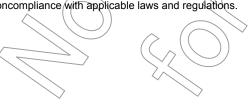


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